

# .049" (1.25mm) Center Wafer Assembly

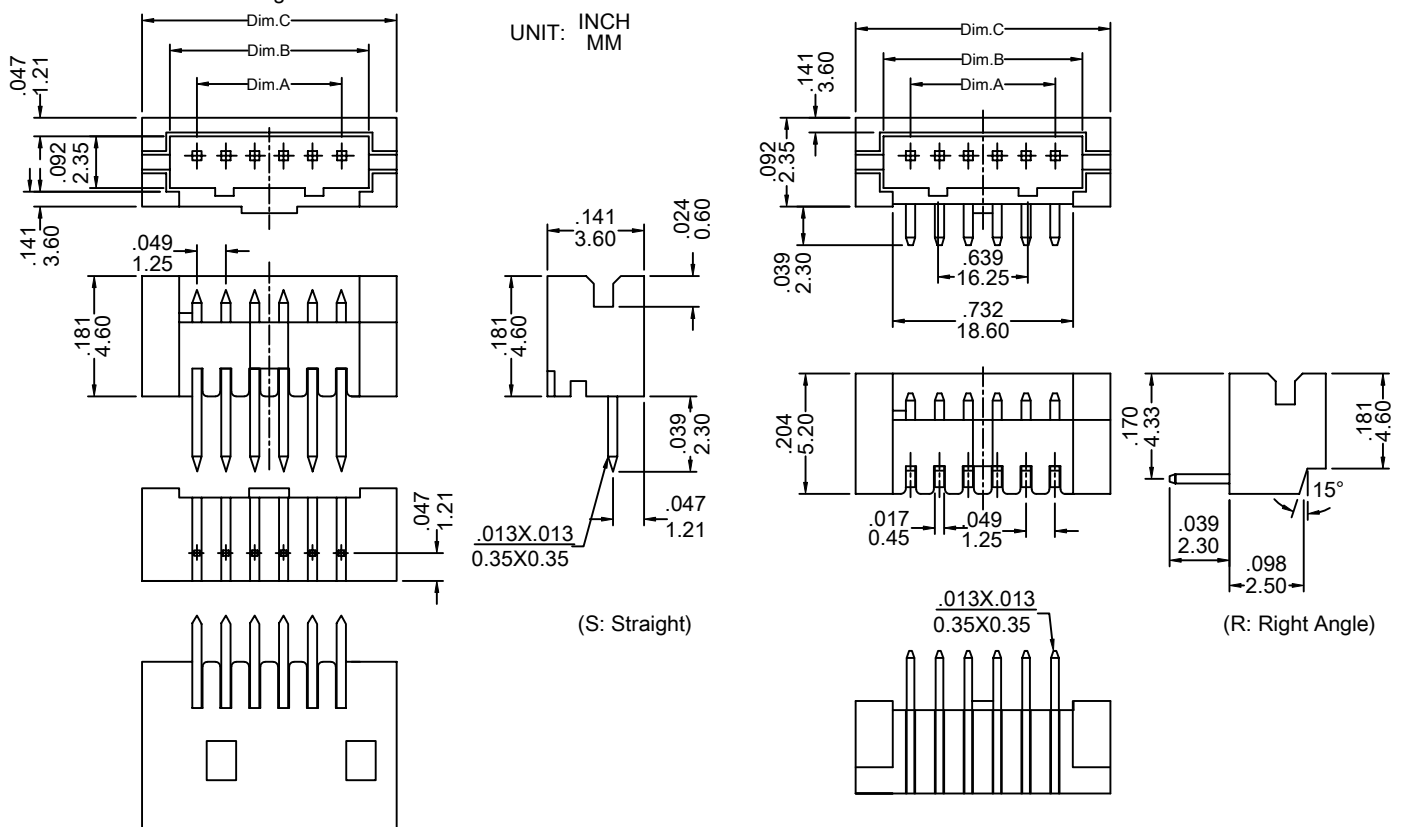
## 1256 Series

### FEATURES:

- . 2-15 Circuits
- . .013" [0.35mm] round wire pins brass
- . Nylon 66, [UL 94V-0]
- . Mates with 1251 PC Board connectors

### SPECIFICATIONS:

- . Current rating: 1A AC, DC
- . Voltage rating: 50V AC, Maximum
- . Temperature range: -25°C ~ +85°C
- . Insulation resistance: 100 MΩ min
- . Withstand Voltage: 800V AC/minute
- . Applicable PC Board thickness: .08 ~ 1.6mm
- . Contact resistance: Initial value/10mΩ max.  
After environmental testing/30mΩ max.



### Ordering Information 1256 Series

Series No.	No. of Contacts	Contact Type	Contact Plating	
1256	- 06P	S	T	- PB
1256 Series	02P ~ 15P	S: Straight R: Right Angle	T: Tin	RoHs

### Dimensional Information

Circuits	Dim.A± .008 0.20	Dim.B± .008 0.20	Dim.C± .008 0.20	Circuits	Dim.A± .008 0.20	Dim.B± .008 0.20	Dim.C± .008 0.20
2	.049 1.25	.120 3.05	.163 4.15	4	.147 3.75	.218 5.55	.261 6.65
3	.098 2.50	.169 4.30	.212 5.40	5	.196 5.00	.267 6.80	.311 7.90

1256 Series

\* FOR CIRCUIT SIZES 6 THROUGH 15 ADD .049" OR 1.25MM FOR EACH ADDITIONAL PIN.